



Release Note for SMDK2416 (Windows Embedded CE 5.0)

S3C2416

Sep 11, 2008

(Preliminary) REV 0.5

Important Notice

The information in this publication has been carefully checked and is believed to be entirely accurate at the time of publication. Samsung assumes no responsibility, however, for possible errors or omissions, or for any consequences resulting from the use of the information contained herein.

Samsung reserves the right to make changes in its products or product specifications with the intent to improve function or design at any time and without notice and is not required to update this documentation to reflect such changes.

This publication does not convey to a purchaser of semiconductor devices described herein any license under the patent rights of Samsung or others.

Samsung makes no warranty, representation, or guarantee regarding the suitability of its products for any particular purpose, nor does Samsung assume any liability arising out of the application or use of any product or circuit and specifically disclaims any and all liability, including without limitation any consequential or incidental damages.

"Typical" parameters can and do vary in different applications. All operating parameters, including "Typicals" must be validated for each customer application by the customer's technical experts.

Samsung products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, for other applications intended to support or sustain life, or for any other application in which the failure of the Samsung product could create a situation where personal injury or death may occur.

Should the Buyer purchase or use a Samsung product for any such unintended or unauthorized application, the Buyer shall indemnify and hold Samsung and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, expenses, and reasonable attorney fees arising out of, either directly or indirectly, any claim of personal injury or death that may be associated with such unintended or unauthorized use, even if such claim alleges that Samsung was negligent regarding the design or manufacture of said product

S3C2450 RISC Microprocessor Release Note

Copyright © 2007-2007 Samsung Electronics Co., Ltd.

All rights reserved. No part of this publication may be reproduced, stored in a retrieval system, or transmitted in any form or by any means, electric or mechanical, by photocopying, recording, or otherwise, without the prior written consent of Samsung Electronics Co., Ltd.

Samsung Electronics Co., Ltd.
San #24 Nongseo-Dong, Giheung-Gu
Yongin-City Gyeonggi-Do, Korea
446-711

Home Page: <http://www.samsungsemi.com/>

E-Mail: mobilesol.cs@samsung.com

Printed in the Republic of Korea



Preliminary product information describe products that are in development, for which full characterization data and associated errata are not yet available. Specifications and information herein are subject to change without notice.

Revision History

Revision No	Description of Change	Refer to	Author(s)	Date
0.1	Preliminary draft	-	SangHee Kim	2007-06-11
0.2	Preliminary draft	-	TS Team	2008-07-11
0.3	Preliminary draft	-	TS Team	2008-07-14
0.4	Preliminary draft	-	Hyuk Lee	2008-08-04
0.5	Preliminary draft	-	Hyuk Lee	2008-09-11

Contents

1	SMDK2416_WINCE50_PM_REL_0.06_080911	III
2	SMDK2416_WINCE50_PM_REL_0.05_080804	IV
3	SMDK2416_WINCE50_PM_REL_0.04_080714	V
4	SMDK2416_WINCE50_PM_REL_0.03_080711	VI
5	SMDK2416_WINCE50_PM_REL_0.01_BETA_080611 BSP RELEASE.....	VII

1 SMDK2416_WinCE50_PM_REL_0.06_080911

Updated at Sep 11, 2008

What's New?

Fixes made in this update

- Code changed for supporting 4KB NAND page.

Known Issues

2 SMDK2416_WinCE50_PM_REL_0.05_080804

Updated at Aug 4, 2008

What's New?

Fixes made in this update

1. IDLE Mode bug is fixed.

Known Issues

- Nothing

3 SMDK2416_WinCE50_PM_REL_0.04_080714

Updated at July 14, 2008

What's New?

Fixes made in this update

2. In previous version, Sleep and WakUp function in Eboot is not Working Well in IROM booting Mode. This bug was fixed.
3. SDMMC D/D has been Fixed the problem on missing the Transfer Complete Interrupt.

Known Issues

- Nothing

4 SMDK2416_WinCE50_PM_REL_0.03_080711

Updated at July 11, 2008

What's New?

4. The function to disable FASTPATH is added. FASTPATH is enabled basically.
5. Sleep fuction in Eboot is Added

Fixes made in this update

1. Write Status Clear Async Mode on HSMMC has been enabled.
 - 1.1. This fix can make async-clear enable about Normal and Error interrupt status bit.
 - 1.2. Because exception handling on status bits is not needed, the performance of HSMMC ISR has been increased.
2. Inserted retention release codes in off.c.
 - 2.1. In previous version, IROM has these codes, but now IROM removes that codes.
 - 2.2. So, retention release codes are inserted in off.c
3. The Interrupt handler of SDMMC driver use "Normal Interrupt Status Register" instead of "Slot Interrupt Status Register", because "Slot Interrupt Status Register" was not applied correctly to the SDMMC controller.

Known Issues

- Nothing

5 SMDK2416_WinCE50_PM_REL_0.01_BETA_080611 BSP Release

Updated at June 11, 2008

What's New?

1. Beta version released.
 - Bootloader, Touch, Display, AC97, NandStorage , PowerSave(IdleMode) is working.
 - HSMMC, IIC, HS-SPI, IrDA,Serial, Post Processor, USB Device, Usb Host, PowerButton driver is working.
 - Audio(IIS), SDIO,2D,CFCon, USB KITL, Sleep, DVS function is working.
2. IROM booting is working.

Fixes made in this update

- Nothing

Known Issues

- Nothing